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# 2SC2613

# Silicon NPN Triple Diffused

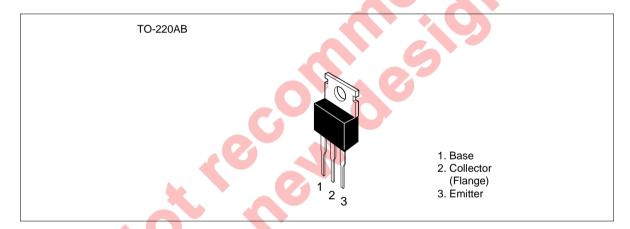


ADE-208-886 (Z) 1st. Edition September 2000

## **Application**

High voltage, high speed and high power switching

## Outline



## **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	500	V
Collector to emitter voltage	V <sub>CEO</sub>	400	V
Emitter to base voltage	$V_{EBO}$	7	V
Collector current	I <sub>c</sub>	5	A
Collector peak current	I <sub>C(peak)</sub>	10	A
Base current	I <sub>B</sub>	2.5	A
Collector power dissipation	P <sub>c</sub> *1	40	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

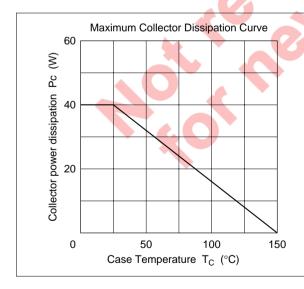
Note: 1. Value at  $T_c = 25$ °C.

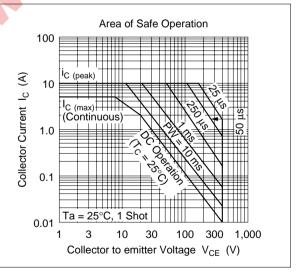
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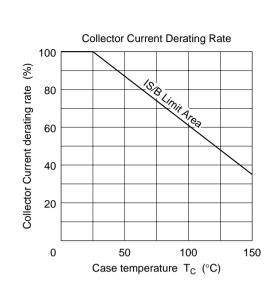
## **Electrical Characteristics** (Ta = 25°C)

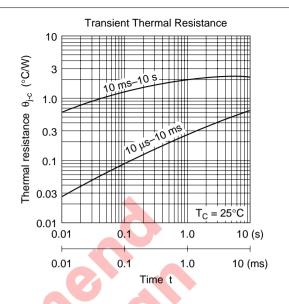
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{\text{CEO(sus)}}$	400	_	_	V	$I_{C} = 0.2 \text{ A}, R_{BE} = \infty,$ L = 100  mH
	$V_{\text{CEX(sus)}}$	400	_	_	V	$I_{C} = 5 \text{ A}, \ I_{B1} = -I_{B2} = 1 \text{ A}$ $V_{BE} = -5 \text{ V}, \ L = 180 \ \mu\text{H},$ Clamped
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	_	_	V	$I_{\rm E} = 10 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	100	μΑ	$V_{CB} = 400 \text{ V}, I_{E} = 0$
	I <sub>CEO</sub>	_	_	100	μΑ	V <sub>CE</sub> = 350 V, R <sub>BE</sub> = ∞
DC current transfer ratio	h <sub>FE1</sub>	15	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 2.5 \text{ A}^{*1}$
	h <sub>FE2</sub>	7	_	_	<b></b>	$V_{CE} = 5 \text{ V}, I_{C} = 5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0	V	$I_{\rm C} = 2.5 \text{ A}, I_{\rm B} = 0.5 \text{ A}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	-	1.5	V	$I_{c} = 2.5 \text{ A}, I_{B} = 0.5 \text{ A}^{*1}$
Turn on time	t <sub>on</sub>	_	7	1.0	μs	$I_{\rm C} = 5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 1 \text{ A},$
Storage time	t <sub>stg</sub>		1.2	2.5	μs	V <sub>cc</sub> ≅ 150 V
Fall time	t <sub>f</sub>	-		1.0	μs	

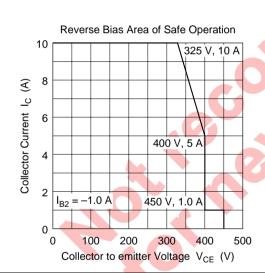
Note: 1. Pulse test.

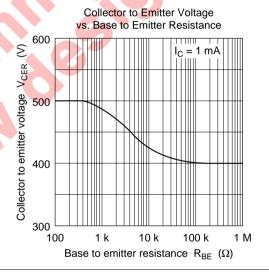


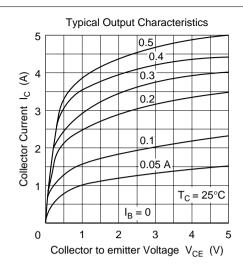


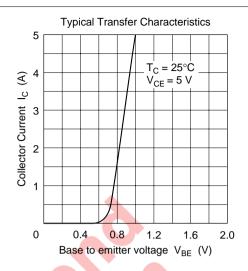


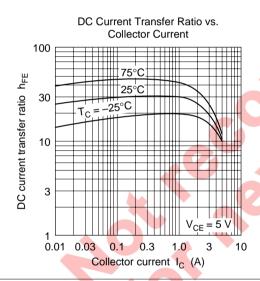


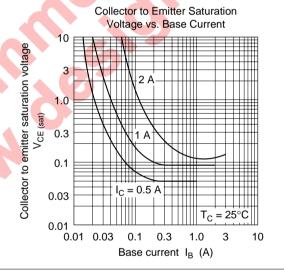


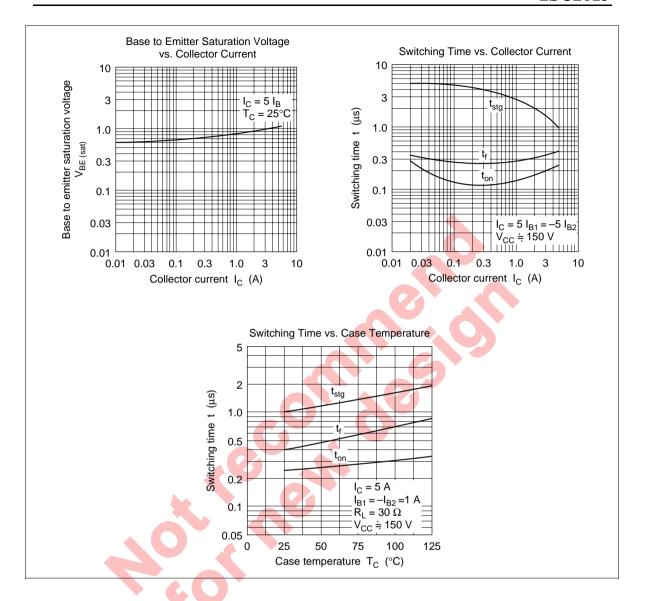












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